

 PAD AREA
 KEEP OUT AREA

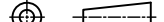
Pin Define:			
CONN Pin No	SD Pin No	Card Pin No	Pin Define
P1		P9	DAT2
P2		P1	DAT3
P3		P2	CMD
P4			CD
P5		P3	VSS1
P6		P4	VDD
P7		P5	CLK
P8		P6	VSS2
P9		P7	DAT0
P10		P8	DAT1
P11			W/P
P12-15			GND

WITHOUT CARD		CARD INSERTED:LOCK		CARD INSERTED:UNLOCK	
W/P 11#	GND 12#	W/P 11#	GND 12#	W/P 11#	GND 12#
C/D 4#	VSS1 5#	C/D 4#	VSS1 5#	C/D 4#	VSS1 5#

2-2 Cover:
Underplating: Ni overall 50U" Min.



深圳市华宇创精密电子有限公司

TOLERANCE:		DRAWN BY :	DATE :	PART NAME:	
X.X ±0.30		陈一鸣	2014-02-23	SD PUSH 沉板板下2.65H	
X.XX ±0.25					
X.XXX ±0.15					
X: ±2° X.X ±0.5°		CHECKED BY:	DATE :	PART NO.	HYC100-SD11-265
		马跃	2014-02-23	MOLD NO.	
UNIT: mm [inch]				APPROVED BY:	DATE :
SCALE:1:1	SIZE: A4	邱敏	2014-02-23	SHEET NO.	1 OF 1